



SuperBlade®

New! Highest-Density Blade Systems for Enterprise, Data Center, HPC and Cloud Computing

Up to 18 Cores and 160W TDP Intel® Xeon® processor E5-2600 v3 Product Family



TwinBlade®

Double Density
20 DP Nodes in 7U



DatacenterBlade®

14-Blade, SAS3 / NVMe



StorageBlade

10-Blade, SAS3 / NVMe

Industry's Highest Density with up to 20 DP Nodes in 7U Enclosure

- 20 DP Nodes per 7U Enclosure
- 4320 Xeon® Cores per 42U Standard Rack
- High Efficiency Platinum Level, Redundant Power Supplies
- Redundant Chassis Management Modules
- 10GbE Layer 2/3 and FCoE Switch Modules
- 56Gbps FDR InfiniBand Switch Modules
- 6 HDDs/SSDs and Dual 160W TDP CPUs per Node with NVMe supported (StorageBlade)



www.supermicro.com/SuperBlade

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